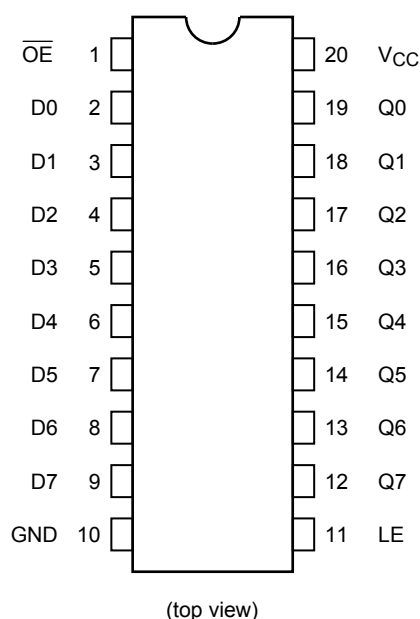
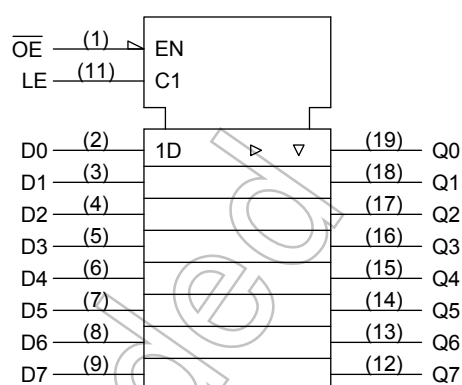


Pin Assignment



IEC Logic Symbol



Truth Table

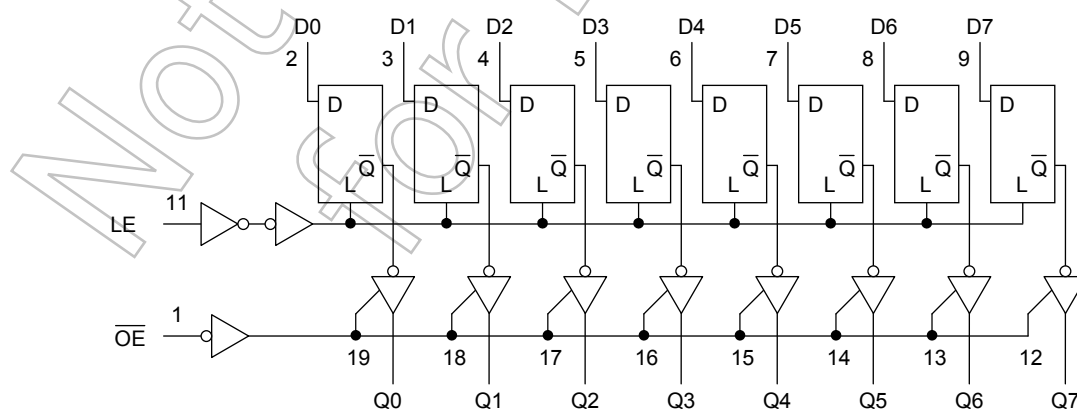
| Inputs | | | Output |
|-----------------|----|---|--------|
| \overline{OE} | LE | D | Q |
| H | X | X | Z |
| L | L | X | Qn |
| L | H | L | L |
| L | H | H | H |

X: Don't care

Z: High impedance

Qn: Q outputs are latched at the time when the LE input is taken to a low logic level.

System Diagram



Absolute Maximum Ratings (Note 1)

| Characteristics | Symbol | Rating | Unit |
|-----------------------------|-----------|------------------------------------|------|
| Supply voltage range | V_{CC} | -0.5 to 7.0 | V |
| DC input voltage | V_{IN} | -0.5 to $V_{CC} + 0.5$ | V |
| DC output voltage | V_{OUT} | -0.5 to $V_{CC} + 0.5$ | V |
| Input diode current | I_{IK} | ± 20 | mA |
| Output diode current | I_{OK} | ± 50 | mA |
| DC output current | I_{OUT} | ± 50 | mA |
| DC V_{CC} /ground current | I_{CC} | ± 200 | mA |
| Power dissipation | P_D | 500 (DIP) (Note 2)/180 (SOP/TSSOP) | mW |
| Storage temperature | T_{stg} | -65 to 150 | °C |

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 2: 500 mW in the range of $T_a = -40$ to 65°C . From $T_a = 65$ to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.

Operating Ranges (Note)

| Characteristics | Symbol | Rating | Unit |
|--------------------------|-----------|---|------|
| Supply voltage | V_{CC} | 2.0 to 5.5 | V |
| Input voltage | V_{IN} | 0 to V_{CC} | V |
| Output voltage | V_{OUT} | 0 to V_{CC} | V |
| Operating temperature | T_{opr} | -40 to 85 | °C |
| Input rise and fall time | dt/dV | 0 to 100 ($V_{CC} = 3.3 \pm 0.3$ V) 0 to 20 ($V_{CC} = 5 \pm 0.5$ V) | ns/V |

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

| Characteristics | Symbol | Test Condition | | Ta = 25°C | | | Ta = -40 to 85°C | | Unit | |
|----------------------------------|-----------------|---|--|------------------------|----------------------|-------------|----------------------|----------------------|------|-----|
| | | | | V _{CC} (V) | Min | Typ. | Max | Min | | Max |
| High-level input voltage | V _{IH} | — | | 2.0 3.0 5.5 | 1.50 2.10 3.85 | — — — | — — — | 1.50 2.10 3.85 | V | |
| Low-level input voltage | V _{IL} | — | | 2.0 3.0 5.5 | — — — | — — — | 0.50 0.90 1.65 | — — — | V | |
| High-level output voltage | V _{OH} | V _{IN} = V _{IH} or V _{IL} | I _{OH} = -50 µA | 2.0 | 1.9 | 2.0 | — | 1.9 | — | V |
| | | | | 3.0 | 2.9 | 3.0 | — | 2.9 | — | |
| | | | | 4.5 | 4.4 | 4.5 | — | 4.4 | — | |
| | | | I _{OH} = -4 mA I _{OH} = -24 mA I _{OH} = -75 mA (Note) | 3.0 | 2.58 | — | — | 2.48 | — | |
| | | | | 4.5 | 3.94 | — | — | 3.80 | — | |
| Low-level output voltage | V _{OL} | V _{IN} = V _{IH} or V _{IL} | I _{OL} = 50 µA | 2.0 | — | 0.0 | 0.1 | — | 0.1 | V |
| | | | | 3.0 | — | 0.0 | 0.1 | — | 0.1 | |
| | | | | 4.5 | — | 0.0 | 0.1 | — | 0.1 | |
| | | | I _{OL} = 12 mA I _{OL} = 24 mA I _{OL} = 75 mA (Note) | 3.0 | — | — | 0.36 | — | 0.44 | |
| | | | | 4.5 | — | — | 0.36 | — | 0.44 | |
| 3-state output off-state current | I _{OZ} | V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND | | 5.5 | — | — | ±0.5 | — | ±5.0 | µA |
| Input leakage current | I _{IN} | V _{IN} = V _{CC} or GND | | 5.5 | — | — | ±0.1 | — | ±1.0 | µA |
| Quiescent supply current | I _{CC} | V _{IN} = V _{CC} or GND | | 5.5 | — | — | 8.0 | — | 80.0 | µA |

Note: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

Timing Requirements (input: t_r = t_f = 3 ns)

| Characteristics | Symbol | Test Condition | V _{CC} (V) | Ta = 25°C | Ta = -40 to 85°C | Unit |
|--------------------------|--------------------|----------------|------------------------|------------|------------------|------|
| | | | | Limit | Limit | |
| Minimum pulse width (LE) | t _w (H) | — | 3.3 ± 0.3 5.0 ± 0.5 | 7.0 5.0 | 7.0 5.0 | ns |
| Minimum set-up time | t _s | — | 3.3 ± 0.3 5.0 ± 0.5 | 7.0 4.0 | 7.0 4.0 | ns |
| Minimum hold time | t _h | — | 3.3 ± 0.3 5.0 ± 0.5 | 1.0 1.0 | 1.0 1.0 | ns |

AC Characteristics ($C_L = 50 \text{ pF}$, $R_L = 500 \Omega$, input: $t_r = t_f = 3 \text{ ns}$)

| Characteristics | Symbol | Test Condition | Ta = 25°C | | | Ta = -40 to 85°C | | Unit |
|----------------------------------|------------------|----------------|---------------------|-----|------|------------------|-----|------|
| | | | V _{CC} (V) | Min | Typ. | Max | Min | Max |
| Propagation delay time (LE-Q) | t _{pLH} | — | 3.3 ± 0.3 | — | 9.4 | 15.4 | 1.0 | 17.6 |
| | t _{pHL} | | 5.0 ± 0.5 | — | 6.6 | 9.9 | 1.0 | 11.3 |
| Propagation delay time (Dn-Q) | t _{pLH} | — | 3.3 ± 0.3 | — | 9.4 | 16.0 | 1.0 | 18.2 |
| | t _{pHL} | | 5.0 ± 0.5 | — | 6.2 | 8.9 | 1.0 | 10.2 |
| Output enable time | t _{pZL} | — | 3.3 ± 0.3 | — | 9.0 | 15.2 | 1.0 | 17.3 |
| | t _{pZH} | | 5.0 ± 0.5 | — | 6.3 | 9.2 | 1.0 | 10.5 |
| Output disable time | t _{pLZ} | — | 3.3 ± 0.3 | — | 7.0 | 12.3 | 1.0 | 14.0 |
| | t _{pHZ} | | 5.0 ± 0.5 | — | 6.0 | 8.8 | 1.0 | 10.0 |
| Input capacitance | C _{IN} | — | — | — | 5 | 10 | — | 10 |
| Output capacitance | C _{OUT} | — | — | — | 10 | — | — | — |
| Power dissipation capacitance | C _{PD} | (Note) | — | — | 32 | — | — | — |

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC(\text{opr})} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per latch)}$$

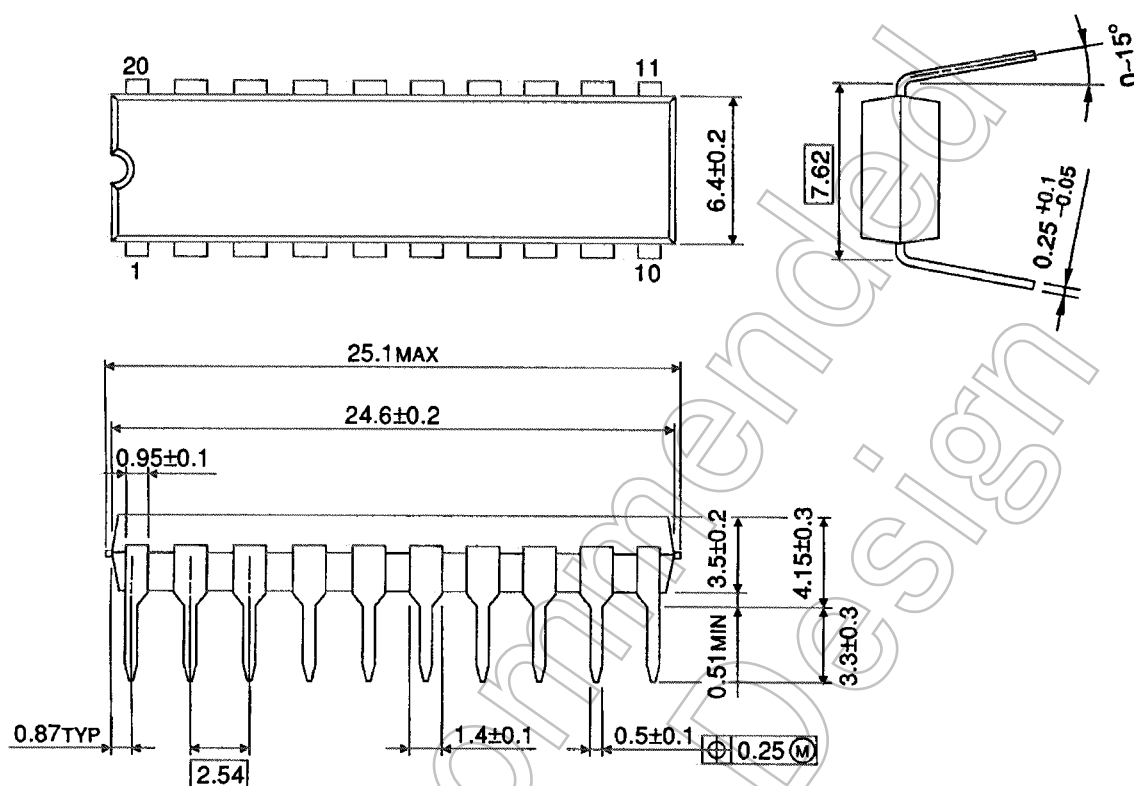
And the total C_{PD} when n pcs. of latch operate can be gained by the following equation:

$$C_{PD(\text{total})} = 21 + 11 \cdot n$$

Package Dimensions

DIP20-P-300-2.54A

Unit : mm

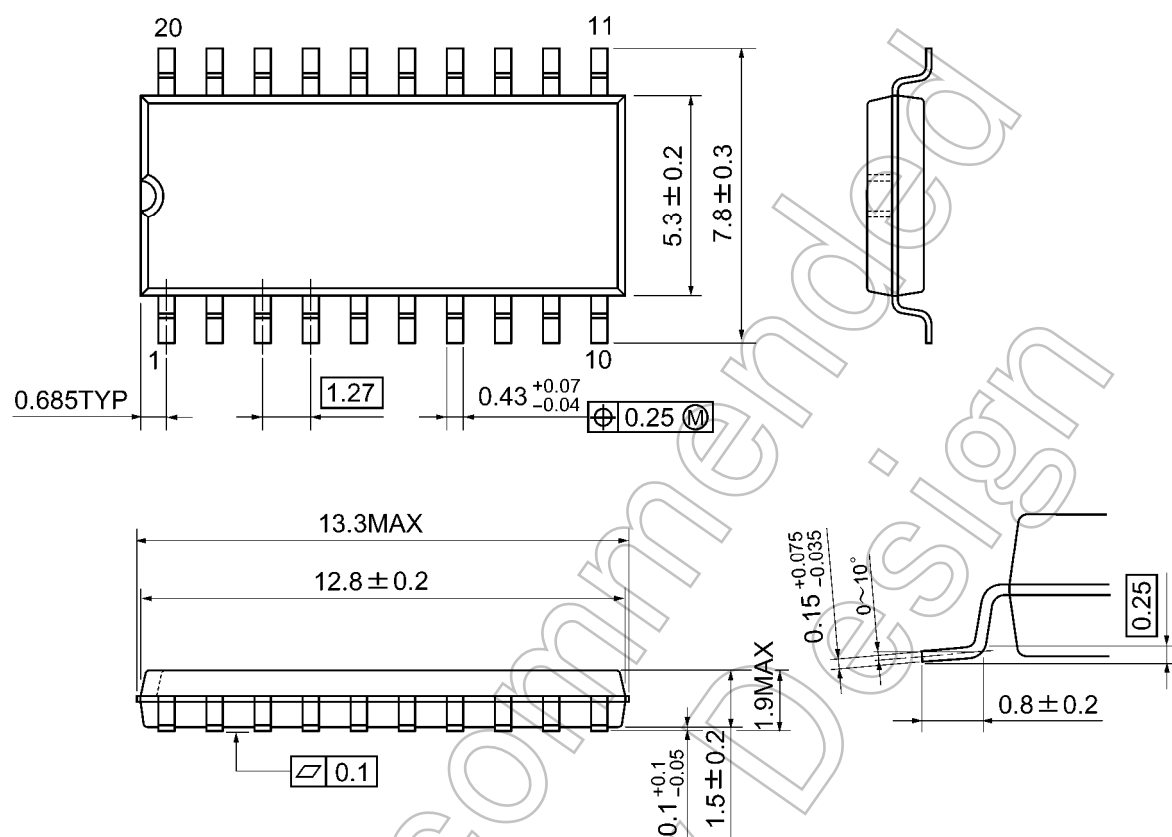


Weight: 1.30 g (typ.)

Package Dimensions

SOP20-P-300-1.27A

Unit: mm

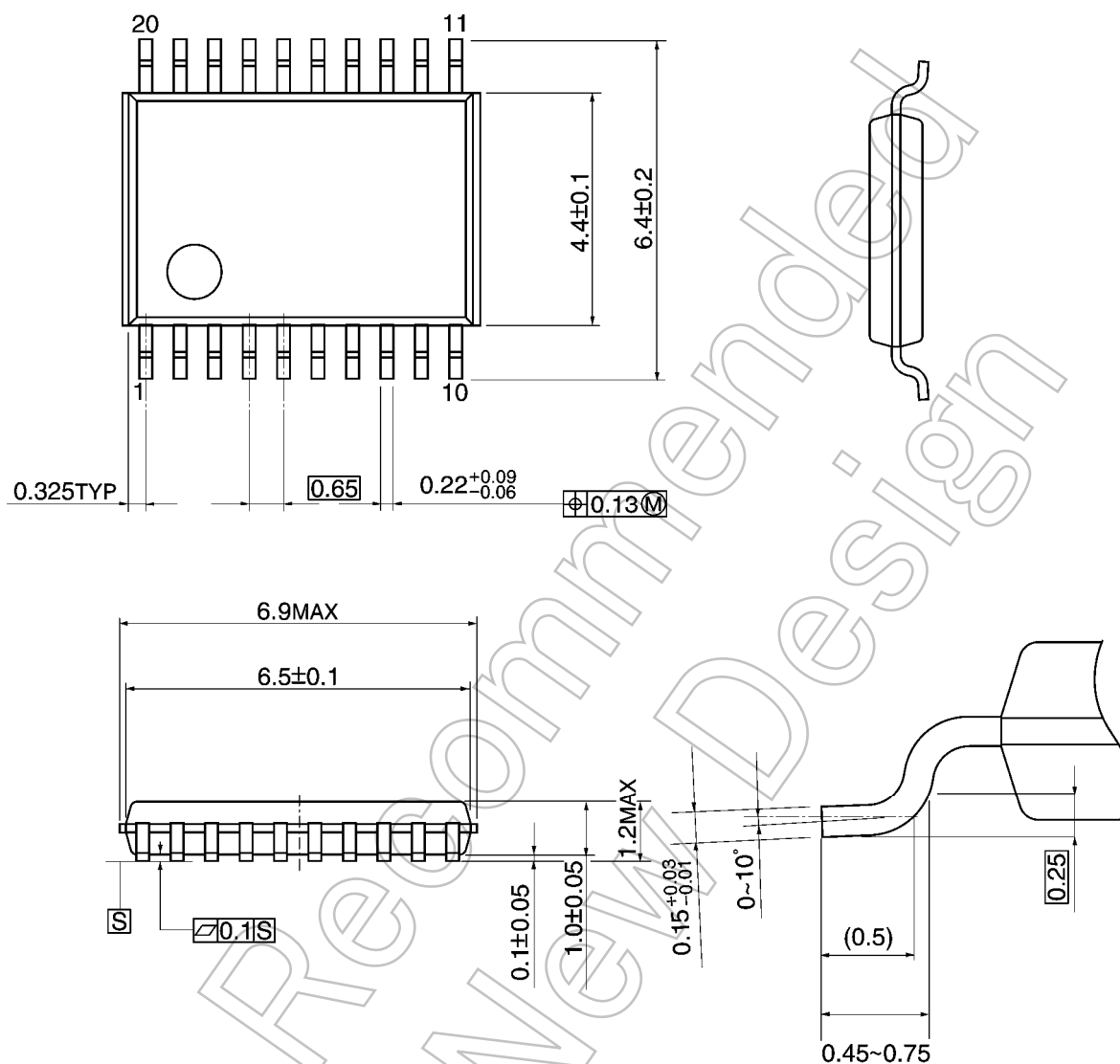


Weight: 0.22 g (typ.)

Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm



Weight: 0.08 g (typ.)

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